



DMN2029UVT

Product Summary

BV _{DSS}	RDS(ON) Max	I _{D Мах} Та = +25°С
20V	24mΩ @ V _{GS} = 4.5V	6.8A
	32mΩ @ V _{GS} = 2.5V	5.9A

Description and Applications

This new generation MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- DC-DC Converters
- Power Management Functions
- Backlighting

N-CHANNEL ENHANCEMENT MODE MOSFET

Features and Benefits

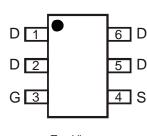
- Low Input Capacitance
- Low On-Resistance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. <u>https://www.diodes.com/quality/product-definitions/</u>

Mechanical Data

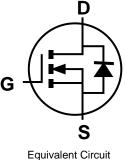
- Case: TSOT26
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Tin Finish Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (63)
- Weight: 0.013 grams (Approximate)



Top View



Top View Pin Configuration



Equivalent Circu

Ordering Information (Note 4)

Part Number	Case	Packaging
DMN2029UVT-7	TSOT26	3,000/Tape & Reel
DMN2029UVT-13	TSOT26	10,000/Tape & Reel

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and

Lead-free. 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information

Notes:

	7		
	AF	R1	ΥW
Ľ]		
	1	2021	202

AR1 = Product Type Marking Code YM = Date Code Marking Y or \overline{Y} = Year (ex: I = 2021) M = Month (ex: 9 = September)

Date Code Key Year 2018 22 2023 2024 2025 2026 2027 2028 2029 2030 K Ρ Code F .1 Μ Ν 0 R S T Month Jan Feb Mar May Jun Jul Sep Oct Nov Dec Apr Aug Code 1 2 3 4 5 6 7 8 9 0 Ν D



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	Vdss	20	V		
Gate-Source Voltage	V _{GSS}	±10	V		
Continuous Drain Current (Note 6) V _{GS} = 4.5V	Steady State	T _A = +25°C	٦D	6.8	А
		T _A = +70°C		5.5	A
Maximum Body Diode Forward Current (Note 6)			ls	2	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			ldм	40	A

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T _A = +25°C	PD	0.7	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	RθJA	109	°C/W
Total Power Dissipation (Note 6)	T _A = +25°C	PD	1.7	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	RθJA	74	
Thermal Resistance, Junction to Case (Note 6)		Rejc	15	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BVDSS	20	_	_	V	V _{GS} = 0V, I _D = 250µA	
Zero Gate Voltage Drain Current	IDSS	_	_	1	μA	$V_{DS} = 16V, V_{GS} = 0V$	
Gate-Source Leakage	IGSS	_	_	±10	μA	$V_{GS} = \pm 8V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(TH)}	0.4	0.7	1.5	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	
Static Drain-Source On-Resistance	Descent	_	18	24	mΩ	V _{GS} = 4.5V, I _D = 6.2A	
Static Drain-Source On-Resistance	Rds(on)	_	21	32	11122	Vgs = 2.5V, ID = 5.2A	
Diode Forward Voltage	V _{SD}	_	0.65	1.2	V	$V_{GS} = 0V, I_{S} = 1.3A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	_	646	_		V _{DS} = 10V, V _{GS} = 0V f = 1.0MHz	
Output Capacitance	Coss	_	78	_	pF		
Reverse Transfer Capacitance	Crss	_	38	_			
Gate Resistance	Rg	_	628		Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge	Qg	_	7.1	_		V _{DS} = 10V, I _D = 6.2A, V _{GS} = 4.5V	
Gate-Source Charge	Q _{gs}		0.9		nC		
Gate-Drain Charge	Q _{gd}		0.7				
Turn-On Delay Time	t _{D(ON)}	_	98	_		V _{DD} = 10V, V _{GS} = 4.5V,	
Turn-On Rise Time	tR		139				
Turn-Off Delay Time	tD(OFF)		1023	_	ns	$I_D = 1A, R_g = 6\Omega$	
Turn-Off Fall Time	tF		433	_			
Reverse Recovery Time	t _{RR}		245		ns	IF = 1.0A, di/dt = 100A/µs	
Reverse Recovery Charge	Qrr		148	_	nC	IF = 1.0A, di/dt = 100A/µs	

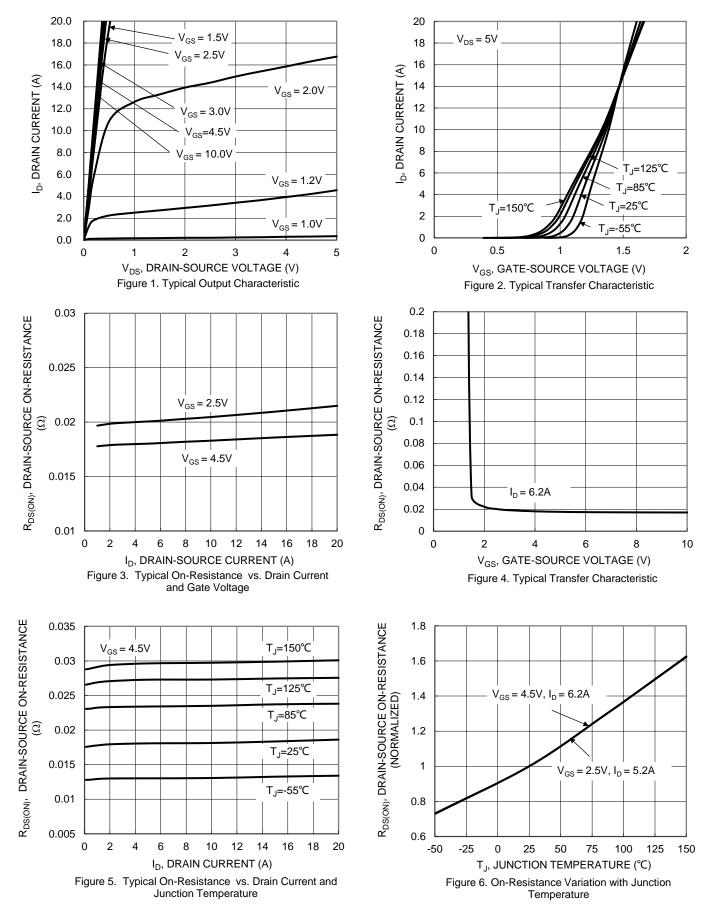
Notes:

Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
Device mounted on FR-4 substrate PC board, 2oz copper, with thermal vias to bottom layer 1inch square copper plate.

7. Short duration pulse test used to minimize self-heating effect.
8. Guaranteed by design. Not subject to production testing.

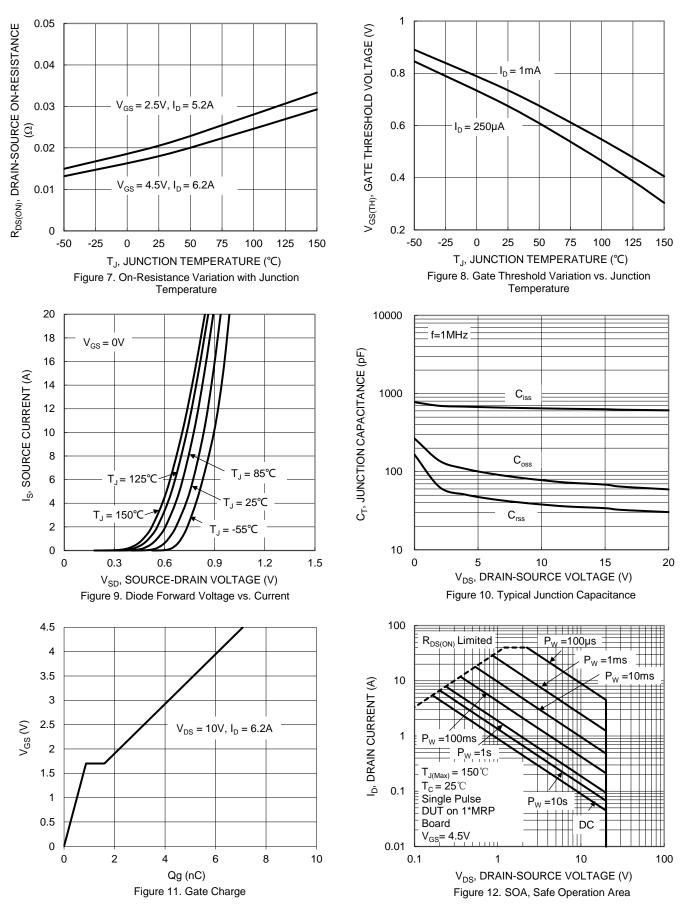


DMN2029UVT

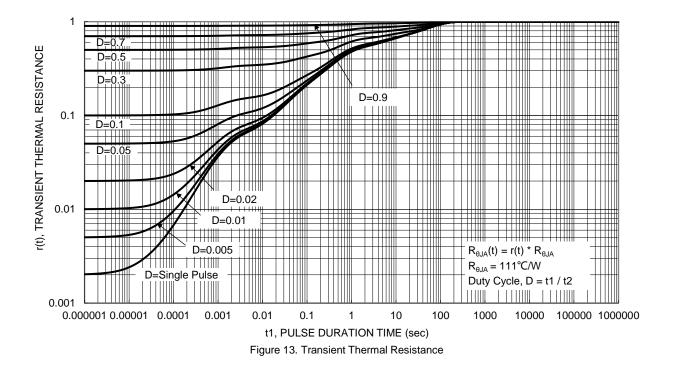




DMN2029UVT



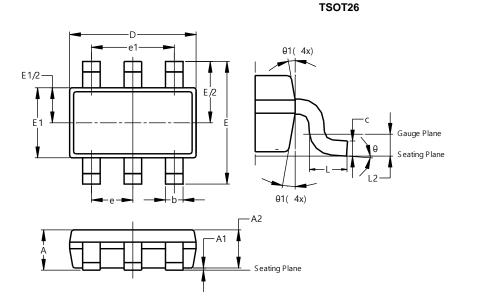






Package Outline Dimensions

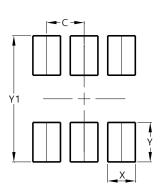
Please see http://www.diodes.com/package-outlines.html for the latest version.



TSOT26						
Dim	Min Max		Тур			
Α	-	1.00	-			
A1	0.010	0.100	-			
A2	0.840	0.900	-			
D	2.800	3.000	2.900			
ш	2	2.800 BSC				
E1	1.500	1.700	1.600			
b	0.300	0.450	-			
С	0.120	0.200	-			
е	0.950 BSC					
e1	1.900 BSC					
L	0.30	0.50	-			
L2	0.250 BSC					
θ	0°	8°	4°			
θ1	4°	12°	_			
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



TSOT26

Dimensions	Value (in mm)
С	0.950
Х	0.700
Y	1.000
Y1	3.200



IMPORTANT NOTICE

1. DIODES INCORPORATED AND ITS SUBSIDIARIES ("DIODES") MAKE NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO ANY INFORMATION CONTAINED IN THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

2. The Information contained herein is for informational purpose only and is provided only to illustrate the operation of Diodes products described herein and application examples. Diodes does not assume any liability arising out of the application or use of this document or any product described herein. This document is intended for skilled and technically trained engineering customers and users who design with Diodes products. Diodes products may be used to facilitate safety-related applications; however, in all instances customers and users are responsible for (a) selecting the appropriate Diodes products for their applications, (b) evaluating the suitability of the Diodes products for their intended applications, (c) ensuring their applications, which incorporate Diodes products, comply the applicable legal and regulatory requirements as well as safety and functional-safety related standards, and (d) ensuring they design with appropriate safeguards (including testing, validation, quality control techniques, redundancy, malfunction prevention, and appropriate treatment for aging degradation) to minimize the risks associated with their applications.

3. Diodes assumes no liability for any application-related information, support, assistance or feedback that may be provided by Diodes from time to time. Any customer or user of this document or products described herein will assume all risks and liabilities associated with such use, and will hold Diodes and all companies whose products are represented herein or on Diodes' websites, harmless against all damages and liabilities.

4. Products described herein may be covered by one or more United States, international or foreign patents and pending patent applications. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks and trademark applications. Diodes does not convey any license under any of its intellectual property rights or the rights of any third parties (including third parties whose products and services may be described in this document or on Diodes' website) under this document.

5 provided subject to Diodes' Standard Terms and Conditions of Sale Diodes products are (https://www.diodes.com/about/company/terms-and-conditions/terms-and-conditions-of-sales/) or other applicable terms. This document does not alter or expand the applicable warranties provided by Diodes. Diodes does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel.

6. Diodes products and technology may not be used for or incorporated into any products or systems whose manufacture, use or sale is prohibited under any applicable laws and regulations. Should customers or users use Diodes products in contravention of any applicable laws or regulations, or for any unintended or unauthorized application, customers and users will (a) be solely responsible for any damages, losses or penalties arising in connection therewith or as a result thereof, and (b) indemnify and hold Diodes and its representatives and agents harmless against any and all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim relating to any noncompliance with the applicable laws and regulations, as well as any unintended or unauthorized application.

7. While efforts have been made to ensure the information contained in this document is accurate, complete and current, it may contain technical inaccuracies, omissions and typographical errors. Diodes does not warrant that information contained in this document is error-free and Diodes is under no obligation to update or otherwise correct this information. Notwithstanding the foregoing, Diodes reserves the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. This document is written in English but may be translated into multiple languages for reference. Only the English version of this document is the final and determinative format released by Diodes.

8. Any unauthorized copying, modification, distribution, transmission, display or other use of this document (or any portion hereof) is prohibited. Diodes assumes no responsibility for any losses incurred by the customers or users or any third parties arising from any such unauthorized use.

Copyright © 2021 Diodes Incorporated

www.diodes.com